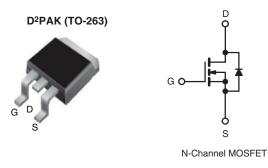
Vishay Siliconix



E Series Power MOSFET

| PRODUCT SUMMARY | | | | | | |
|--|-----------------|-----|--|--|--|--|
| V _{DS} (V) at T _J max. | 700 | | | | | |
| R _{DS(on)} max. at 25 °C (Ω) | $V_{GS} = 10 V$ | 0.6 | | | | |
| Q _g max. (nC) | 48 | | | | | |
| Q _{gs} (nC) | 6 | | | | | |
| Q _{gd} (nC) | 11 | | | | | |
| Configuration | guration Single | | | | | |



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

| ORDERING INFORMATION | | | | | |
|---------------------------------|-----------------------------|--|--|--|--|
| Package | D ² PAK (TO-263) | | | | |
| Lead (Pb)-free and Halogen-free | SiHB6N65E-GE3 | | | | |

| PARAMETER | SYMBOL | LIMIT | UNIT | | |
|---|-----------------------------------|---|-----------------|------|---|
| | | | | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 650 | v |
| Gate-Source Voltage | V _{GS} | ± 30 | v | | |
| Continuous Drain Current (T ₁ = 150 °C) | V =+ 10 V | T _C = 25 °C T _C = 100 °C | | 7 | |
| Continuous Drain Current $(1_j = 150^{\circ} C)$ | V _{GS} at 10 V | T _C = 100 °C | I _D | 5 | А |
| Pulsed Drain Current ^a | I _{DM} | 18 | | | |
| Linear Derating Factor | | 0.63 | W/°C | | |
| Single Pulse Avalanche Energy ^b | E _{AS} | 56 | mJ | | |
| Maximum Power Dissipation | PD | 78 | W | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-Source Voltage Slope | -IV / / -I+ | 37 | | | |
| Reverse Diode dV/dt ^d | dV/dt | 27 | V/ns | | |
| Soldering Recommendations (Peak Temperature) ^c | | 300 | °C | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 2$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

1 For technical questions, contact: <u>hvm@vishay.com</u> HALOGEN

FREE



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| PARAMETER | SYMBOL | TYP. MAX. | | | UNIT | | |
|---|-----------------------|--|---|------|------|-------|------|
| Maximum Junction-to-Ambient | | | | | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | | | | °C/W | | |
| | 1 | | | | | | |
| SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, (| unless otherw | ise noted) | | | | | |
| PARAMETER | SYMBOL | 1 | T CONDITIONS | MIN. | TYP. | MAX. | UNI |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | Vasi | = 0 V, I _D = 250 μΑ | 650 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | e to 25 °C, I _D = 1 mA | - | 0.73 | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | | = V _{GS} , I _D = 250 μA | 2 | - | 4 | V |
| - • • | | | $V_{GS} = \pm 20 V$ | | - | ± 100 | nA |
| Gate-Source Leakage | | | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μA |
| | | | = 650 V, V _{GS} = 0 V | - | - | 1 | μΑ |
| Zero Gate Voltage Drain Current | I _{DSS} | | /, V _{GS} = 0 V, T _J = 125 °C | - | - | 10 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | | | 0.5 | 0.6 | Ω |
| Forward Transconductance | 9 _{fs} | $V_{DS} = 30 \text{ V}, \text{ I}_{D} = 3 \text{ A}$ | | - | 2 | - | S |
| Dynamic | • | • | | | • | • | • |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 100 V, | | - | 820 | - | pF |
| Output Capacitance | C _{oss} | | | - | 40 | - | |
| Reverse Transfer Capacitance | C _{rss} | | f = 1 MHz | | 4 | - | |
| Effective Output Capacitance, Energy Related ^a | C _{o(er)} | V_{DS} = 0 V to 520 V, V_{GS} = 0 V | | - | 36 | - | |
| Effective Output Capacitance, Time Related ^b | C _{o(tr)} | | | - | 117 | - | |
| Total Gate Charge | Qg | V _{GS} = 10 V I _D = 3 A, V _{DS} = 520 V | | - | 24 | 48 | nC |
| Gate-Source Charge | Q _{gs} | | | - | 6 | - | |
| Gate-Drain Charge | Q _{gd} | | | - | 11 | - | 1 |
| Turn-On Delay Time | t _{d(on)} | | | - | 14 | 28 | |
| Rise Time | t _r | V _{DD} = 520 V, I _D = 3 A, | | - | 12 | 24 | |
| Turn-Off Delay Time | t _{d(off)} | V _{GS} = | $V_{DD} = 320$ V, $T_D = 3$ A, $V_{GS} = 10$ V, $R_q = 9.1 \Omega$ | | 30 | 60 | - ns |
| Fall Time | t _f | | | - | 20 | 40 | |
| Gate Input Resistance | R _g | f = 1 MHz, open drain | | - | 1.4 | - | Ω |
| Drain-Source Body Diode Characteristi | cs | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 7 | |
| Pulsed Diode Forward Current | I _{SM} | | | - | - | 18 | A |
| Diode Forward Voltage | V _{SD} | T _J = 25 ° | C, I _S = 3 A, V _{GS} = 0 V | - | - | 1.3 | V |
| Reverse Recovery Time | t _{rr} | | | - | 237 | - | ns |
| Reverse Recovery Charge | Q _{rr} | | $25 \text{ °C}, I_F = I_S = 3 \text{ A},$ | - | 2.2 | - | μC |
| Reverse Recovery Current | I _{RRM} | dl/dt = 100 A/µs, V _R = 25 V | | _ | 16 | _ | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

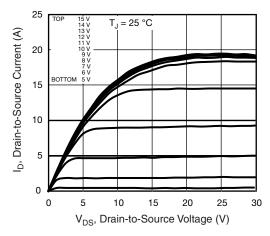


Fig. 1 - Typical Output Characteristics

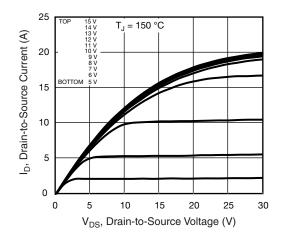


Fig. 2 - Typical Output Characteristics

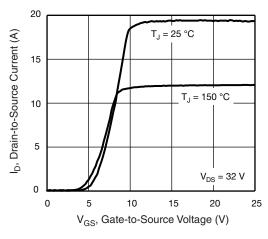


Fig. 3 - Typical Transfer Characteristics

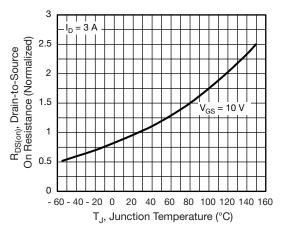


Fig. 4 - Normalized On-Resistance vs. Temperature

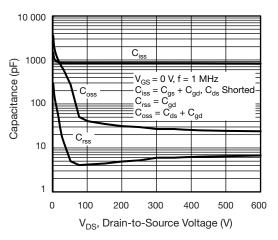
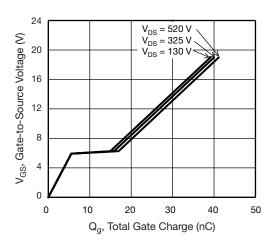
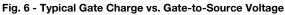


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





S15-0399-Rev. B, 16-Mar-15

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91544

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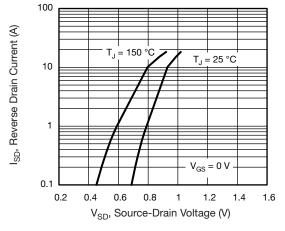


Fig. 7 - Typical Source-Drain Diode Forward Voltage

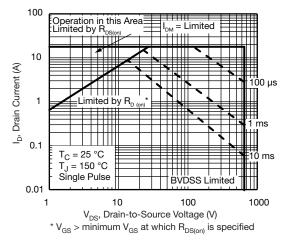


Fig. 8 - Maximum Safe Operating Area

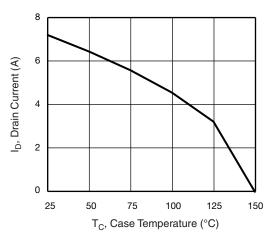


Fig. 9 - Maximum Drain Current vs. Case Temperature

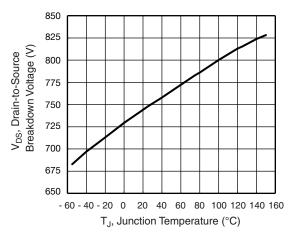
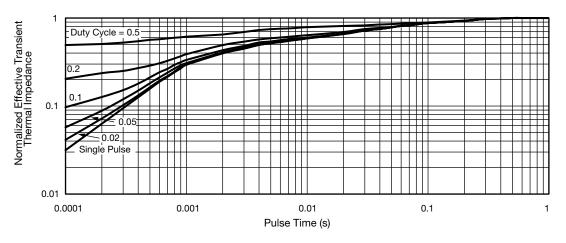


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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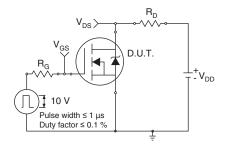


Fig. 12 - Switching Time Test Circuit

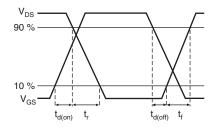


Fig. 13 - Switching Time Waveforms

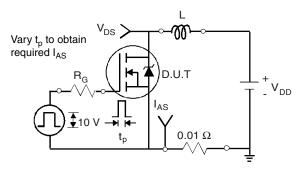


Fig. 14 - Unclamped Inductive Test Circuit

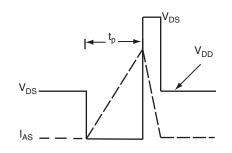


Fig. 15 - Unclamped Inductive Waveforms

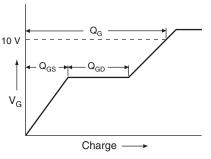


Fig. 16 - Basic Gate Charge Waveform

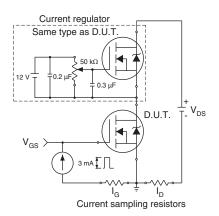


Fig. 17 - Gate Charge Test Circuit

5



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Peak Diode Recovery dV/dt Test Circuit

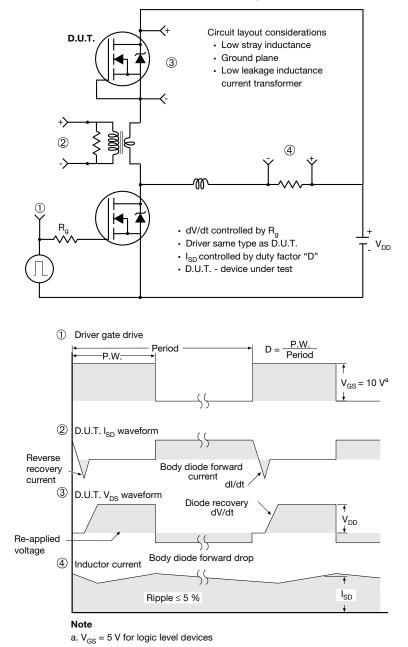


Fig. 18 - For N-Channel

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Document Number: 91544

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4

2 x 🗗

A

н

−2 x b2 <−2 x b

Plating

ł

Detail A

(Datum A)

D

 $\underline{4}$ 11

| | | Lead tip | | (c) (c) (b, b2) (c) | | | $E1 \longrightarrow 4$ | | | | | |
|------|-------------|----------|--------|--|--|-------------|------------------------|--------|-----------|-------|--|--|
| | MILLIMETERS | | INCHES | | | MILLIMETERS | | INCHES | | | | |
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX. | | |
| А | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | - | 0.270 | - | | |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | | Е | 9.65 | 10.67 | 0.380 | 0.420 | | |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 6.22 | - | 0.245 | - | | |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | | е | 2.54 BSC | | 0.100 BSC | | | |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | | Н | 14.61 | 15.88 | 0.575 | 0.625 | | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | | L | 1.78 | 2.79 | 0.070 | 0.110 | | |
| С | 0.38 | 0.74 | 0.015 | 0.029 | | L1 | - | 1.65 | - | 0.066 | | |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | | L2 | - | 1.78 | - | 0.070 | | |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | | L3 | 0.25 BSC | | 0.010 BSC | | | |
| D | 8.38 | 9.65 | 0.330 | 0.380 | | L4 | 4.78 | 5.28 | 0.188 | 0.208 | | |

А

Δ

// ± 0.004 M B

b1, b3

Base metal

- Notes
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



H

B

A1

D1 4

Gauge plane

. Ŀ3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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